



Note: Input Filtering May Need Adjusting

90VAC-277VAC Input

24V@0.6A

Assembly Notes:

Built on PMP9018 Rev_A PCB

Ref. Des. > 99 have been added on the board

DNP = "Do Not Populate"



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Designed for:	Mod. Date: 10/17/2013	
Project Title: 90-277VAC Input, 24V@0.6A Flyback	Sheet Title:	
Number: PMP8706	Rev: A	Sheet 1 of 1
SVN Rev.: Not in version control	Assembly Variant: Variant name not interpreted	File: PMP8706_REVA_sheet1.SchDoc
Drawn By:	Size: B	http://www.ti.com
Engineer: R. Scibilia	Contact: http://www.ti.com/support	© Texas Instruments 2013

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